

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	("20020060368").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/18 13:25
L2	2	("5959363").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/18 13:25
L6	43	(US-4388132-\$ or US-6827981-\$ or US-6416869-\$ or US-6261638-\$ or US-5002831-\$ or US-5001011-\$ or US-4961967-\$ or US-RE34675-\$ or US-5089300-\$ or US-5041593-\$ or US-5006573-\$ or US-4871788-\$ or US-4863978-\$ or US-4849294-\$ or US-4800125-\$ or US-4719262-\$ or US-4718944-\$ or US-4690959-\$ or US-4689085-\$ or US-6620719-\$ or US-6054769-\$ or US-5928791-\$ or US-5736251-\$ or US-5078475-\$ or US-5053048-\$ or US-4786528-\$).did. or (US-3854793-\$ or US-5639555-\$ or US-6281567-\$ or US-6265776-\$ or US-6228681-\$ or US-6228678-\$ or US-6404643-\$ or US-6350840-\$ or US-6238223-\$ or US-6194788-\$ or US-6180187-\$ or US-6108210-\$ or US-6063828-\$ or US-6057381-\$ or US-5783867-\$ or US-5212402-\$).did. or (US-3079361-\$).did.	USPAT; USOCR	OR	ON	2005/11/18 16:08
L7	8	monolayer and 6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 16:24
L8	1593546	@ad>"20000405"@rfad>"20000405"@pt1d>"20000405"	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/18 16:24
L9	77523	\$12silan\$5 not L8	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/18 16:24
L10	273	monolayer with L9	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 16:24
L11	4	("4231910").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/18 16:27
L12	10877	\$glycidoxypopyltrimethoxysilane\$ \$ethyltrimethoxysilane\$ not 6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 16:29
L13	30	10 and 12	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 17:10
L14	243	10 not 13	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 17:10
L15	167	(adhesion coupling primer) and 14	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 17:21
L16	0	monomolecular with 12	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 17:21
L17	246	monomolecular with 9	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 17:29
L18	224	17 not 14	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 18:09
L19	144	plueddemann.in. ((hoge lin).in. and borroughs.as.) not L8	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/18 18:10
L22	4	plueddemann.in. not L19	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 18:30
L24	1	9 and 22	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 18:11

L25	2538	Yamada-Hiroshi.in. not 8	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 18:30
L26	31	wet\$5 and 25	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/18 18:31
S1	2	("5959363").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/17 18:36
S2	2	("20020060368").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/17 18:37
S3	2	("4388132").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/17 18:44
S4	4	("4231910").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/17 18:44
S5	6	S3 S4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/17 18:44
S6	51	("3177170" "3193424" "3306800" "3488310" "3664982" "3852690" "3963551" "4001154").PN. OR ("4231910" "4388132").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 18:45
S7	1593546	@ad>"20000405" @riad>"20000405" @pt1d>"20000405"	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 18:45
S8	44	S6 not S7	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 18:48
S10	144	plueddemann.in. ((hoge lin).in. and borroughs.as.) not S7	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 18:48
S13	77523	\$12\$ilan\$5 not S7	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 18:52
S14	18	S13 and S8	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 19:07
S15	62	S13 and S10 not (S7 S14)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 19:16
S16	3	underfil\$ with S13	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 19:18
S17	20260	monolayer not S7	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 19:18
S18	0	S17 and (S14 S15)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 19:20
S19	273	S17 with S13	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 19:20
S20	1153265	coupling adhesion not S7	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 19:20
S21	38	S19 with S20	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 19:20
S24	577	thermoset\$ with S13 not S7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/17 19:43
S26	6	underfil\$ and S24	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/17 19:45
S28	241	S13 with S20 with thermoset\$	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/17 20:00

S29	6	("5864178").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/17 20:18
S30	4	thermoplastic with thermosetting with underfil\$ not S7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/17 20:22
S31	7	thermoplastic with thermoset\$ with underfil\$ not (S7 S30)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/17 20:35
S32	876	capillar\$ with thermoplastic not S7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/17 20:36
S33	2201555	semiconductor integrated adj circuit ic "438"/\$.ccls. "257"/\$.ccls. 228/180.22.ccls. not S7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/17 20:37
S34	24	S32 and S33	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/17 20:39
S35	43	thermoplastic with underfil\$ not S7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/17 20:40
S36	23	thermoset\$ and S35	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/17 20:40